

# IS41C85120

# IS41LV85120



## 512K x 8 (4-MBIT) DYNAMIC RAM WITH EDO PAGE MODE

PRELIMINARY INFORMATION  
SEPTEMBER 2001

### FEATURES

- TTL compatible inputs and outputs
- Refresh Interval: 1024 cycles/16 ms
- Refresh Mode :  $\overline{\text{RAS}}$ -Only,  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  (CBR), and Hidden
- JEDEC standard pinout
- Single power supply
  - 5V  $\pm$  10% (IS41C85120)
  - 3.3V  $\pm$  10% (IS41LV85120)
- Industrail Temperature Range -40°C to 85°C

### KEY TIMING PARAMETERS

| Parameter                                                     | -35 | -60 | Unit |
|---------------------------------------------------------------|-----|-----|------|
| Max. $\overline{\text{RAS}}$ Access Time ( $t_{\text{RAC}}$ ) | 35  | 60  | ns   |
| Max. $\overline{\text{CAS}}$ Access Time ( $t_{\text{CAC}}$ ) | 10  | 15  | ns   |
| Max. Column Address Access Time ( $t_{\text{AA}}$ )           | 18  | 30  | ns   |
| Min. Fast Page Mode Cycle Time ( $t_{\text{PC}}$ )            | 12  | 25  | ns   |
| Min. Read/Write Cycle Time ( $t_{\text{RC}}$ )                | 60  | 110 | ns   |

### PIN DESCRIPTIONS

|                         |                       |
|-------------------------|-----------------------|
| A0-A9                   | Address Inputs        |
| I/O0-I/O7               | Data Inputs/Outputs   |
| $\overline{\text{WE}}$  | Write Enable          |
| $\overline{\text{OE}}$  | Output Enable         |
| $\overline{\text{RAS}}$ | Row Address Strobe    |
| $\overline{\text{CAS}}$ | Column Address Strobe |
| Vcc                     | Power                 |
| GND                     | Ground                |
| NC                      | No Connection         |

### DESCRIPTION

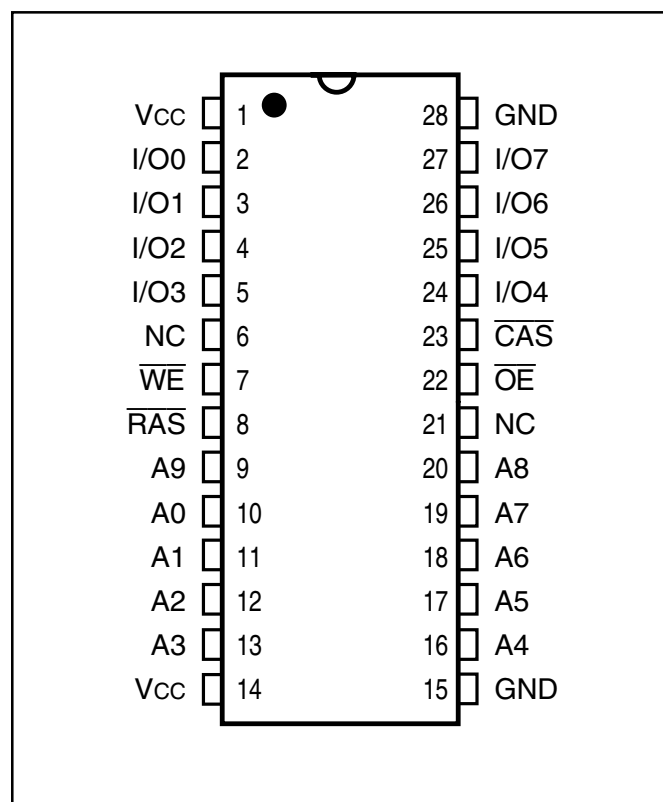
The *ISSI* IS41C85120 and IS41LV85120 are 524,288 x 8-bit high-performance CMOS Dynamic Random Access Memory. Both products offer accelerated cycle access EDO Page Mode. EDO Page Mode allows 512 random accesses within a single row with access cycle time as short as 10ns per 8-bit word. The Byte Write control, of upper and lower byte, makes the IS41C85120 and IS41LV85120 ideal for use in 16 and 32-bit wide data bus systems.

These features make the IS41C85120 and IS41LV85120 ideally suited for high band-width graphics, digital signal processing, high-performance computing systems, and peripheral applications.

The IS41C85120 and IS41LV85120 are available in a 28-pin, 400-mil SOJ package.

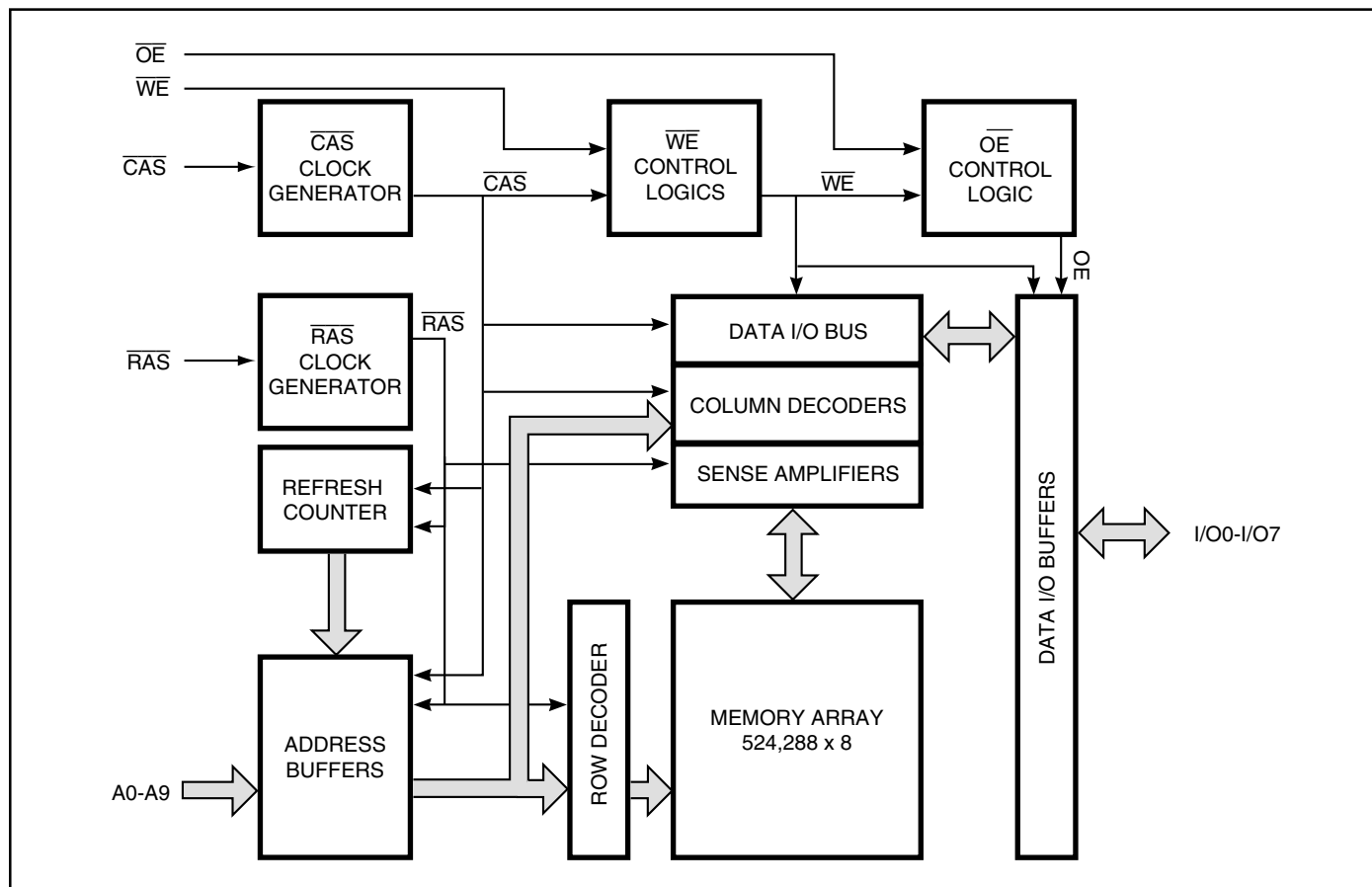
### PIN CONFIGURATION

#### 28-Pin SOJ



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## FUNCTIONAL BLOCK DIAGRAM



## TRUTH TABLE

| Function                                              | $\overline{\text{RAS}}$ | $\overline{\text{CAS}}$ | $\overline{\text{WE}}$ | $\overline{\text{OE}}$ | Address $t_{\text{R}}/t_{\text{C}}$ | I/O                                                |
|-------------------------------------------------------|-------------------------|-------------------------|------------------------|------------------------|-------------------------------------|----------------------------------------------------|
| Standby                                               | H                       | H                       | X                      | X                      | X                                   | High-Z                                             |
| Read: Word                                            | L                       | L                       | H                      | L                      | ROW/COL                             | D <sub>OUT</sub>                                   |
| Read: Lower Byte                                      | L                       | L                       | H                      | L                      | ROW/COL                             | Lower Byte, D <sub>OUT</sub><br>Upper Byte, High-Z |
| Read: Upper Byte                                      | L                       | H                       | H                      | L                      | ROW/COL                             | Lower Byte, High-Z<br>Upper Byte, D <sub>OUT</sub> |
| Write: Word (Early Write)                             | L                       | L                       | L                      | X                      | ROW/COL                             | D <sub>IN</sub>                                    |
| Write: Lower Byte (Early Write)                       | L                       | L                       | L                      | X                      | ROW/COL                             | Lower Byte, D <sub>IN</sub><br>Upper Byte, High-Z  |
| Write: Upper Byte (Early Write)                       | L                       | H                       | L                      | X                      | ROW/COL                             | Lower Byte, High-Z<br>Upper Byte, D <sub>IN</sub>  |
| Read-Write <sup>(1,2)</sup>                           | L                       | L                       | H→L                    | L→H                    | ROW/COL                             | D <sub>OUT</sub> , D <sub>IN</sub>                 |
| EDO Page-Mode Read <sup>(2)</sup><br>D <sub>OUT</sub> | 1st Cycle:              | L                       | H→L                    | H                      | L                                   | ROW/COL                                            |
|                                                       | 2nd Cycle:              | L                       | H→L                    | H                      | L                                   | NA/COL D <sub>OUT</sub>                            |
|                                                       | Any Cycle:              | L                       | L→H                    | H                      | L                                   | NA/NA D <sub>OUT</sub>                             |
| EDO Page-Mode Write <sup>(1)</sup>                    | 1st Cycle:              | L                       | H→L                    | L                      | X                                   | ROW/COL D <sub>IN</sub>                            |
|                                                       | 2nd Cycle:              | L                       | H→L                    | L                      | X                                   | NA/COL D <sub>IN</sub>                             |
| EDO Page-Mode<br>D <sub>OUT</sub> , D <sub>IN</sub>   | 1st Cycle:              | L                       | H→L                    | H→L                    | L→H                                 | ROW/COL                                            |
| Read-Write <sup>(1,2)</sup>                           | 2nd Cycle:              | L                       | H→L                    | H→L                    | L→H                                 | NA/COL D <sub>OUT</sub> , D <sub>IN</sub>          |
| Hidden Refresh <sup>(2)</sup><br>D <sub>OUT</sub>     | Read                    | L→H→L                   | L                      | H                      | L                                   | ROW/COL                                            |
|                                                       | Write                   | L→H→L                   | L                      | L                      | X                                   | ROW/COL                                            |
| D <sub>OUT</sub>                                      |                         |                         |                        |                        |                                     |                                                    |
| $\overline{\text{RAS}}$ -Only Refresh                 | L                       | H                       | X                      | X                      | ROW/NA                              | High-Z                                             |
| CBR Refresh <sup>(3)</sup>                            | H→L                     | L                       | X                      | X                      | X                                   | High-Z                                             |

### Notes:

1. These WRITE cycles may also be BYTE WRITE cycles (either  $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$  active).
2. These READ cycles may also be BYTE READ cycles (either  $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$  active).
3. At least one of the two CAS signals must be active ( $\overline{\text{LCAS}}$  or  $\overline{\text{UCAS}}$ ).

## Functional Description

The IS41C85120 and IS41LV85120 is a CMOS DRAM optimized for high-speed bandwidth, low power applications. During READ or WRITE cycles, each bit is uniquely addressed through the 19 address bits. The first ten address bits (A0-A9) are entered as row address and latter nine bits nine address bits (A0-A8) are entered as column address. The row address is latched by the Row Address Strobe ( $\overline{\text{RAS}}$ ). The column address is latched by the Column Address Strobe ( $\overline{\text{CAS}}$ ).  $\overline{\text{RAS}}$  is used to latch the first nine bits and  $\overline{\text{CAS}}$  is used the latter nine bits.

## Memory Cycle

A memory cycle is initiated by bring  $\overline{\text{RAS}}$  LOW and it is terminated by returning both  $\overline{\text{RAS}}$  and  $\overline{\text{CAS}}$  HIGH. To ensures proper device operation and data integrity any memory cycle, once initiated, must not be ended or aborted before the minimum  $t_{\text{RAS}}$  time has expired. A new cycle must not be initiated until the minimum precharge time  $t_{\text{RP}}$ ,  $t_{\text{CP}}$  has elapsed.

## Read Cycle

A read cycle is initiated by the falling edge of  $\overline{\text{CAS}}$  or  $\overline{\text{OE}}$ , whichever occurs last, while holding  $\overline{\text{WE}}$  HIGH. The column address must be held for a minimum time specified by  $t_{\text{AR}}$ . Data Out becomes valid only when  $t_{\text{RAC}}$ ,  $t_{\text{AA}}$ ,  $t_{\text{CAC}}$  and  $t_{\text{OEA}}$  are all satisfied. As a result, the access time is dependent on the timing relationships between these parameters.

## Write Cycle

A write cycle is initiated by the falling edge of  $\overline{\text{CAS}}$  and  $\overline{\text{WE}}$ , whichever occurs last. The input data must be valid at or before the falling edge of  $\overline{\text{CAS}}$  or  $\overline{\text{WE}}$ , whichever occurs last.

## Refresh Cycle

To retain data, 1024 refresh cycles are required in each 16 ms period. There are two ways to refresh the memory.

1. By clocking each of the 1024 row addresses (A0 through A9) with  $\overline{\text{RAS}}$  at least once every 16 ms. Any read, write, read-modify-write or  $\overline{\text{RAS}}$ -only cycle refreshes the addressed row.
2. Using a  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh cycle.  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh is activated by the falling edge of  $\overline{\text{RAS}}$ , while holding  $\overline{\text{CAS}}$  LOW. In  $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  refresh cycle, an internal 10-bit counter provides the row addresses and the external address inputs are ignored.

$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$  is a refresh-only mode and no data access or device selection is allowed. Thus, the output remains in the High-Z state during the cycle.

## Extended Data Out Page Mode

EDO page mode operation permits all 512 columns within a selected row to be randomly accessed at a high data rate.

In EDO page mode read cycle, the data-out is held to the next  $\overline{\text{CAS}}$  cycle's falling edge, instead of the rising edge. For this reason, the valid data output time in EDO page mode is extended compared with the fast page mode. In the fast page mode, the valid data output time becomes shorter as the  $\overline{\text{CAS}}$  cycle time becomes shorter. Therefore, in EDO page mode, the timing margin in read cycle is larger than that of the fast page mode even if the  $\overline{\text{CAS}}$  cycle time becomes shorter.

In EDO page mode, due to the extended data function, the  $\overline{\text{CAS}}$  cycle time can be shorter than in the fast page mode if the timing margin is the same.

The EDO page mode allows both read and write operations during one  $\overline{\text{RAS}}$  cycle, but the performance is equivalent to that of the fast page mode in that case.

## Power-On

After application of the  $V_{\text{CC}}$  supply, an initial pause of 200  $\mu\text{s}$  is required followed by a minimum of eight initialization cycles (any combination of cycles containing a  $\overline{\text{RAS}}$  signal).

During power-on, it is recommended that  $\overline{\text{RAS}}$  track with  $V_{\text{CC}}$  or be held at a valid  $V_{\text{IH}}$  to avoid current surges.

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| Symbol           | Parameters                         | Rating      | Unit           |
|------------------|------------------------------------|-------------|----------------|
| V <sub>T</sub>   | Voltage on Any Pin Relative to GND | 5V          | -1.0 to +7.0 V |
|                  |                                    | 3.3V        | -0.5 to 4.6 V  |
| V <sub>CC</sub>  | Supply Voltage                     | 5V          | -1.0 to +7.0 V |
|                  |                                    | 3.3V        | -0.5 to 4.6 V  |
| I <sub>OUT</sub> | Output Current                     | 50          | mA             |
| P <sub>D</sub>   | Power Dissipation                  | 1           | W              |
| T <sub>A</sub>   | Commercial Operation Temperature   | 0 to +70    | °C             |
|                  | Industrail Temperature             | -40 to +85  | °C             |
| T <sub>STG</sub> | Storage Temperature                | -55 to +125 | °C             |

### Note:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## RECOMMENDED OPERATING CONDITIONS (Voltages are referenced to GND.)

| Symbol          | Parameter                      | Min. | Typ. | Max. | Unit                  |
|-----------------|--------------------------------|------|------|------|-----------------------|
| V <sub>CC</sub> | Supply Voltage                 | 5V   | 4.5  | 5.0  | V                     |
|                 |                                | 3.3V | 3.0  | 3.3  |                       |
| V <sub>IH</sub> | Input High Voltage             | 5V   | 2.4  | —    | V <sub>CC</sub> + 1.0 |
|                 |                                | 3.3V | 2.0  | —    | V <sub>CC</sub> + 0.3 |
| V <sub>IL</sub> | Input Low Voltage              | 5V   | -1.0 | —    | 0.8                   |
|                 |                                | 3.3V | -0.3 | —    | 0.8                   |
| T <sub>A</sub>  | Commercial Ambient Temperature | 0    | —    | 70   | °C                    |
|                 | Industrail Ambient Temperature | -40  | —    | 85   | °C                    |

## CAPACITANCE<sup>(1,2)</sup>

| Symbol           | Parameter                                                                                                              | Max. | Unit |
|------------------|------------------------------------------------------------------------------------------------------------------------|------|------|
| C <sub>IN1</sub> | Input Capacitance: A0-A9                                                                                               | 5    | pF   |
| C <sub>IN2</sub> | Input Capacitance: $\overline{\text{RAS}}$ , $\overline{\text{CAS}}$ , $\overline{\text{WE}}$ , $\overline{\text{OE}}$ | 7    | pF   |
| C <sub>IO</sub>  | Data Input/Output Capacitance: I/O0-I/O7                                                                               | 7    | pF   |

### Notes:

1. Tested initially and after any design or process changes that may affect these parameters.
2. Test conditions: T<sub>A</sub> = 25°C, f = 1 MHz,

## ELECTRICAL CHARACTERISTICS<sup>(1)</sup>

(Recommended Operation Conditions unless otherwise noted.)

| Symbol           | Parameter                                                                                   | Test Condition                                                                                     | Speed                                                            | Min.             | Max.             | Unit |
|------------------|---------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------|------------------------------------------------------------------|------------------|------------------|------|
| I <sub>IL</sub>  | Input Leakage Current                                                                       | Any input $0V \leq V_{IN} \leq V_{CC}$<br>Other inputs not under test = 0V                         |                                                                  | -10              | 10               | μA   |
| I <sub>IO</sub>  | Output Leakage Current                                                                      | Output is disabled (Hi-Z)<br>$0V \leq V_{OUT} \leq V_{CC}$                                         |                                                                  | -10              | 10               | μA   |
| V <sub>OH</sub>  | Output High Voltage Level                                                                   | I <sub>OH</sub> = -2.5 mA                                                                          |                                                                  | 2.4              | —                | V    |
| V <sub>OL</sub>  | Output Low Voltage Level                                                                    | I <sub>OL</sub> = +2.1 mA                                                                          |                                                                  | —                | 0.4              | V    |
| I <sub>CC1</sub> | Stand-by Current: TTL                                                                       | $\overline{RAS}, \overline{CAS} \geq V_{IH}$                                                       | Commercial 5V<br>Industrial 5V<br>Commercial 3V<br>Industrial 3V | —<br>—<br>—<br>— | 3<br>4<br>2<br>3 | mA   |
| I <sub>CC2</sub> | Stand-by Current: CMOS                                                                      | $\overline{RAS}, \overline{CAS} \geq V_{CC} - 0.2V$                                                | 5V<br>3V                                                         | —<br>—           | 2<br>1           | mA   |
| I <sub>CC3</sub> | Operating Current:<br>Random Read/Write <sup>(2,3,4)</sup><br>Average Power Supply Current  | $\overline{RAS}, \overline{CAS}$ ,<br>Address Cycling, t <sub>RC</sub> = t <sub>RC</sub> (min.)    | -35<br>-60                                                       | —<br>—           | 230<br>170       | mA   |
| I <sub>CC4</sub> | Operating Current:<br>EDO Page Mode <sup>(2,3,4)</sup><br>Average Power Supply Current      | $\overline{RAS} = V_{IL}, \overline{CAS}$ ,<br>Cycling t <sub>PC</sub> = t <sub>PC</sub> (min.)    | -35<br>-60                                                       | —<br>—           | 220<br>160       | mA   |
| I <sub>CC5</sub> | Refresh Current:<br>$\overline{RAS}$ -Only <sup>(2,3)</sup><br>Average Power Supply Current | $\overline{RAS}$ Cycling, $\overline{CAS} \geq V_{IH}$<br>t <sub>RC</sub> = t <sub>RC</sub> (min.) | -35<br>-60                                                       | —<br>—           | 230<br>170       | mA   |
| I <sub>CC6</sub> | Refresh Current:<br>CBR <sup>(2,3,5)</sup><br>Average Power Supply Current                  | $\overline{RAS}, \overline{CAS}$ Cycling<br>t <sub>RC</sub> = t <sub>RC</sub> (min.)               | -35<br>-60                                                       | —<br>—           | 230<br>170       | mA   |

### Notes:

1. An initial pause of 200 μs is required after power-up followed by eight  $\overline{RAS}$  refresh cycles ( $\overline{RAS}$ -Only or CBR) before proper device operation is assured. The eight  $\overline{RAS}$  cycles wake-up should be repeated any time the t<sub>REF</sub> refresh requirement is exceeded.
2. Dependent on cycle rates.
3. Specified values are obtained with minimum cycle time and the output open.
4. Column-address is changed once each EDO page cycle.
5. Enables on-chip refresh and address counters.

**AC CHARACTERISTICS** (1,2,3,4,5,6)

(Recommended Operating Conditions unless otherwise noted.)

| Symbol                             | Parameter                                                                                  | -35  |      | -60  |      | Units |
|------------------------------------|--------------------------------------------------------------------------------------------|------|------|------|------|-------|
|                                    |                                                                                            | Min. | Max. | Min. | Max. |       |
| t <sub>RC</sub>                    | Random READ or WRITE Cycle Time                                                            | 60   | —    | 110  | —    | ns    |
| t <sub>RAC</sub>                   | Access Time from $\overline{\text{RAS}}$ <sup>(6, 7)</sup>                                 | 35   | —    | 60   | —    | ns    |
| t <sub>CAC</sub>                   | Access Time from $\overline{\text{CAS}}$ <sup>(6, 8, 15)</sup>                             | —    | 10   | —    | 15   | ns    |
| t <sub>AA</sub>                    | Access Time from Column-Address <sup>(6)</sup>                                             | —    | 18   | —    | 30   | ns    |
| t <sub>RAS</sub>                   | $\overline{\text{RAS}}$ Pulse Width                                                        | 35   | 10K  | 60   | 10K  | ns    |
| t <sub>RP</sub>                    | $\overline{\text{RAS}}$ Precharge Time                                                     | 20   | —    | 40   | —    | ns    |
| t <sub>CAS</sub>                   | $\overline{\text{CAS}}$ Pulse Width <sup>(26)</sup>                                        | 6    | 10K  | 10   | 10K  | ns    |
| t <sub>CP</sub>                    | $\overline{\text{CAS}}$ Precharge Time <sup>(9, 25)</sup>                                  | 5    | —    | 10   | —    | ns    |
| t <sub>CSH</sub>                   | $\overline{\text{CAS}}$ Hold Time <sup>(21)</sup>                                          | 35   | —    | 60   | —    | ns    |
| t <sub>RCD</sub>                   | $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Delay Time <sup>(10, 20)</sup>          | 11   | 28   | 20   | 45   | ns    |
| t <sub>ASR</sub>                   | Row-Address Setup Time                                                                     | 0    | —    | 0    | —    | ns    |
| t <sub>RAH</sub>                   | Row-Address Hold Time                                                                      | 6    | —    | 10   | —    | ns    |
| t <sub>ASC</sub>                   | Column-Address Setup Time <sup>(20)</sup>                                                  | 0    | —    | 0    | —    | ns    |
| t <sub>CAH</sub>                   | Column-Address Hold Time <sup>(20)</sup>                                                   | 6    | —    | 10   | —    | ns    |
| t <sub>AR</sub>                    | Column-Address Hold Time<br>(referenced to $\overline{\text{RAS}}$ )                       | 30   | —    | 40   | —    | ns    |
| t <sub>RAD</sub>                   | $\overline{\text{RAS}}$ to Column-Address Delay Time <sup>(11)</sup>                       | 10   | 20   | 15   | 30   | ns    |
| t <sub>RAL</sub>                   | Column-Address to $\overline{\text{RAS}}$ Lead Time                                        | 18   | —    | 30   | —    | ns    |
| t <sub>RPC</sub>                   | $\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Precharge Time                          | 0    | —    | 0    | —    | ns    |
| t <sub>RSH</sub>                   | $\overline{\text{RAS}}$ Hold Time <sup>(27)</sup>                                          | 8    | —    | 115  | —    | ns    |
| t <sub>CLZ</sub>                   | $\overline{\text{CAS}}$ to Output in Low-Z <sup>(15, 29)</sup>                             | 3    | —    | 3    | —    | ns    |
| t <sub>CRP</sub>                   | $\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ Precharge Time <sup>(21)</sup>          | 5    | —    | 5    | —    | ns    |
| t <sub>OD</sub>                    | Output Disable Time <sup>(19, 28, 29)</sup>                                                | 3    | 12   | 3    | 12   | ns    |
| t <sub>OE</sub> / t <sub>OEA</sub> | Output Enable Time <sup>(15, 16)</sup>                                                     | 0    | 10   | —    | 15   | ns    |
| t <sub>OEHC</sub>                  | $\overline{\text{OE}}$ HIGH Hold Time from $\overline{\text{CAS}}$ HIGH                    | 10   | —    | 10   | —    | ns    |
| t <sub>OE P</sub>                  | $\overline{\text{OE}}$ HIGH Pulse Width                                                    | 10   | —    | 10   | —    | ns    |
| t <sub>OES</sub>                   | $\overline{\text{OE}}$ LOW to $\overline{\text{CAS}}$ HIGH Setup Time                      | 5    | —    | 5    | —    | ns    |
| t <sub>RCS</sub>                   | Read Command Setup Time <sup>(17, 20)</sup>                                                | 0    | —    | 0    | —    | ns    |
| t <sub>RRH</sub>                   | Read Command Hold Time<br>(referenced to $\overline{\text{RAS}}$ ) <sup>(12)</sup>         | 0    | —    | 0    | —    | ns    |
| t <sub>RCH</sub>                   | Read Command Hold Time<br>(referenced to $\overline{\text{CAS}}$ ) <sup>(12, 17, 21)</sup> | 0    | —    | 0    | —    | ns    |
| t <sub>WCH</sub>                   | Write Command Hold Time <sup>(17, 27)</sup>                                                | 5    | —    | 10   | —    | ns    |
| t <sub>WCR</sub>                   | Write Command Hold Time<br>(referenced to $\overline{\text{RAS}}$ ) <sup>(17)</sup>        | 30   | —    | 50   | —    | ns    |

**AC CHARACTERISTICS** (Continued)<sup>(1,2,3,4,5,6)</sup>

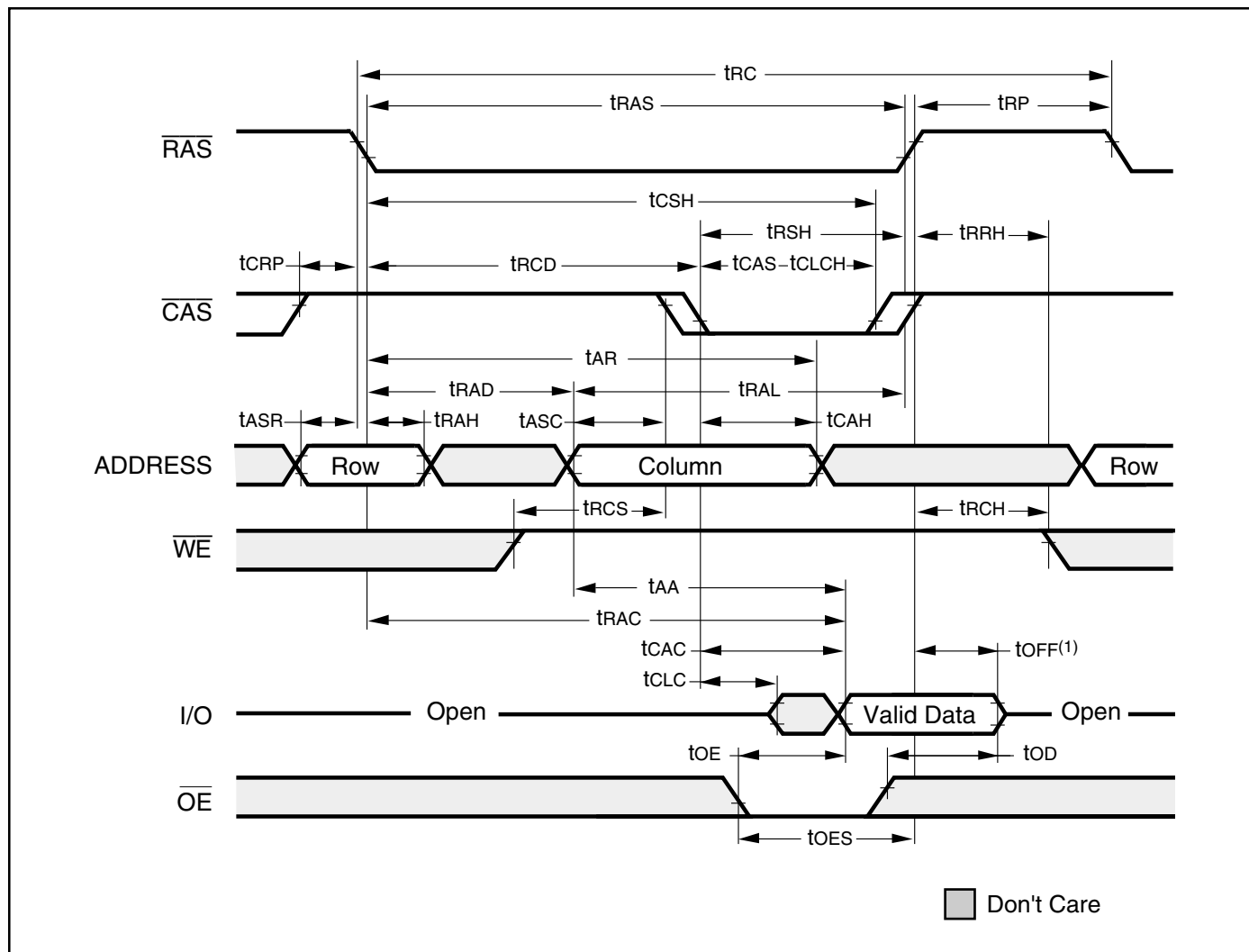
(Recommended Operating Conditions unless otherwise noted.)

| Symbol    | Parameter                                                                                           | -35  |      | -60  |      | Units |
|-----------|-----------------------------------------------------------------------------------------------------|------|------|------|------|-------|
|           |                                                                                                     | Min. | Max. | Min. | Max. |       |
| tWP       | Write Command Pulse Width <sup>(17)</sup>                                                           | 5    | —    | 10   | —    | ns    |
| tWPZ      | $\overline{WE}$ Pulse Widths to Disable Outputs                                                     | 10   | —    | 10   | —    | ns    |
| tRWL      | Write Command to $\overline{RAS}$ Lead Time <sup>(17)</sup>                                         | 8    | —    | 15   | —    | ns    |
| tCWL      | Write Command to $\overline{CAS}$ Lead Time <sup>(17, 21)</sup>                                     | 8    | —    | 15   | —    | ns    |
| twCS      | Write Command Setup Time <sup>(14, 17, 20)</sup>                                                    | 0    | —    | 0    | —    | ns    |
| tdHR      | Data-in Hold Time (referenced to $\overline{RAS}$ )<br>Precharge during WRITE Cycle                 | 30   | —    | 40   | —    | ns    |
| toEH      | $\overline{OE}$ Hold Time from $\overline{WE}$ during<br>READ-MODIFY-WRITE cycle <sup>(18)</sup>    | 8    | —    | 15   | —    | ns    |
| tdS       | Data-In Setup Time <sup>(15, 22)</sup>                                                              | 0    | —    | 0    | —    | ns    |
| tdH       | Data-In Hold Time <sup>(15, 22)</sup>                                                               | 6    | —    | 10   | —    | ns    |
| tRWC      | READ-MODIFY-WRITE Cycle Time                                                                        | 80   | —    | 140  | —    | ns    |
| tRWD      | $\overline{RAS}$ to $\overline{WE}$ Delay Time during<br>READ-MODIFY-WRITE Cycle <sup>(14)</sup>    | 45   | —    | 80   | —    | ns    |
| tcWD      | $\overline{CAS}$ to $\overline{WE}$ Delay Time <sup>(14, 20)</sup>                                  | 25   | —    | 36   | —    | ns    |
| tAWD      | Column-Address to $\overline{WE}$ Delay Time <sup>(14)</sup>                                        | 30   | —    | 49   | —    | ns    |
| tPC       | EDO Page Mode READ or WRITE<br>Cycle Time <sup>(24)</sup>                                           | 12   | —    | 25   | —    | ns    |
| tRASP     | $\overline{RAS}$ Pulse Width in EDO Page Mode                                                       | 35   | 100K | 60   | 100K | ns    |
| tCPA      | Access Time from $\overline{CAS}$ Precharge <sup>(15)</sup>                                         | —    | 21   | —    | 34   | ns    |
| tPRWC     | EDO Page Mode READ-WRITE<br>Cycle Time <sup>(24)</sup>                                              | 40   | —    | 56   | —    | ns    |
| tCOH/tDOH | Data Output Hold after $\overline{CAS}$ LOW                                                         | 5    | —    | 5    | —    | ns    |
| tOFF      | Output Buffer Turn-Off Delay from<br>$\overline{CAS}$ or $\overline{RAS}$ <sup>(13,15,19, 29)</sup> | 3    | 15   | 3    | 15   | ns    |
| tWHZ      | Output Disable Delay from $\overline{WE}$                                                           | 3    | 15   | 3    | 15   | ns    |
| tCLCH     | Last $\overline{CAS}$ going LOW to First $\overline{CAS}$<br>returning HIGH <sup>(23)</sup>         | 10   | —    | 10   | —    | ns    |
| tCSR      | $\overline{CAS}$ Setup Time (CBR REFRESH) <sup>(30, 20)</sup>                                       | 8    | —    | 10   | —    | ns    |
| tCHR      | $\overline{CAS}$ Hold Time (CBR REFRESH) <sup>(30, 21)</sup>                                        | 8    | —    | 10   | —    | ns    |
| tORD      | $\overline{OE}$ Setup Time prior to $\overline{RAS}$ during<br>HIDDEN REFRESH Cycle                 | 0    | —    | 0    | —    | ns    |
| tREF      | Refresh Period (1024 Cycles)                                                                        | —    | 16   | —    | 16   | ms    |
| tr        | Transition Time (Rise or Fall) <sup>(2, 3)</sup>                                                    | 1    | 50   | 1    | 50   | ns    |

**Notes:**

1. An initial pause of 200  $\mu$ s is required after power-up followed by eight  $\overline{\text{RAS}}$  refresh cycle ( $\overline{\text{RAS}}$ -Only or CBR) before proper device operation is assured. The eight  $\overline{\text{RAS}}$  cycles wake-up should be repeated any time the  $t_{\text{REF}}$  refresh requirement is exceeded.
2.  $V_{\text{IH}}$  (MIN) and  $V_{\text{IL}}$  (MAX) are reference levels for measuring timing of input signals. Transition times, are measured between  $V_{\text{IH}}$  and  $V_{\text{IL}}$  (or between  $V_{\text{IL}}$  and  $V_{\text{IH}}$ ) and assume to be 1 ns for all inputs.
3. In addition to meeting the transition rate specification, all input signals must transit between  $V_{\text{IH}}$  and  $V_{\text{IL}}$  (or between  $V_{\text{IL}}$  and  $V_{\text{IH}}$ ) in a monotonic manner.
4. If  $\overline{\text{CAS}}$  and  $\overline{\text{RAS}} = V_{\text{IH}}$ , data output is High-Z.
5. If  $\overline{\text{CAS}} = V_{\text{IL}}$ , data output may contain data from the last valid READ cycle.
6. Measured with a load equivalent to one TTL gate and 50 pF.
7. Assumes that  $t_{\text{RCD}} = t_{\text{RCD}}(\text{MAX})$ . If  $t_{\text{RCD}}$  is greater than the maximum recommended value shown in this table,  $t_{\text{RAC}}$  will increase by the amount that  $t_{\text{RCD}}$  exceeds the value shown.
8. Assumes that  $t_{\text{RCD}} \bullet t_{\text{RCD}}(\text{MAX})$ .
9. If  $\overline{\text{CAS}}$  is LOW at the falling edge of  $\overline{\text{RAS}}$ , data out will be maintained from the previous cycle. To initiate a new cycle and clear the data output buffer,  $\overline{\text{CAS}}$  and  $\overline{\text{RAS}}$  must be pulsed for  $t_{\text{CP}}$ .
10. Operation with the  $t_{\text{RCD}}(\text{MAX})$  limit ensures that  $t_{\text{RAC}}(\text{MAX})$  can be met.  $t_{\text{RCD}}(\text{MAX})$  is specified as a reference point only; if  $t_{\text{RCD}}$  is greater than the specified  $t_{\text{RCD}}(\text{MAX})$  limit, access time is controlled exclusively by  $t_{\text{CAC}}$ .
11. Operation within the  $t_{\text{RAD}}(\text{MAX})$  limit ensures that  $t_{\text{RCD}}(\text{MAX})$  can be met.  $t_{\text{RAD}}(\text{MAX})$  is specified as a reference point only; if  $t_{\text{RAD}}$  is greater than the specified  $t_{\text{RAD}}(\text{MAX})$  limit, access time is controlled exclusively by  $t_{\text{AA}}$ .
12. Either  $t_{\text{RCH}}$  or  $t_{\text{RRH}}$  must be satisfied for a READ cycle.
13.  $t_{\text{OFF}}(\text{MAX})$  defines the time at which the output achieves the open circuit condition; it is not a reference to  $V_{\text{OH}}$  or  $V_{\text{OL}}$ .
14.  $t_{\text{WCS}}$ ,  $t_{\text{RWD}}$ ,  $t_{\text{AWD}}$  and  $t_{\text{CWD}}$  are restrictive operating parameters in LATE WRITE and READ-MODIFY-WRITE cycle only. If  $t_{\text{WCS}} \bullet t_{\text{WCS}}(\text{MIN})$ , the cycle is an EARLY WRITE cycle and the data output will remain open circuit throughout the entire cycle. If  $t_{\text{RWD}} \bullet t_{\text{RWD}}(\text{MIN})$ ,  $t_{\text{AWD}} \bullet t_{\text{AWD}}(\text{MIN})$  and  $t_{\text{CWD}} \bullet t_{\text{CWD}}(\text{MIN})$ , the cycle is a READ-WRITE cycle and the data output will contain data read from the selected cell. If neither of the above conditions is met, the state of I/O (at access time and until  $\overline{\text{CAS}}$  and  $\overline{\text{RAS}}$  or  $\overline{\text{OE}}$  go back to  $V_{\text{IH}}$ ) is indeterminate.  $\overline{\text{OE}}$  held HIGH and  $\overline{\text{WE}}$  taken LOW after  $\overline{\text{CAS}}$  goes LOW result in a LATE WRITE ( $\overline{\text{OE}}$ -controlled) cycle.
15. Output parameter (I/O) is referenced to corresponding  $\overline{\text{CAS}}$  input, I/O0-I/O7 by  $\overline{\text{LCAS}}$  and I/O8-I/O15 by  $\overline{\text{UCAS}}$ .
16. During a READ cycle, if  $\overline{\text{OE}}$  is LOW then taken HIGH before  $\overline{\text{CAS}}$  goes HIGH, I/O goes open. If  $\overline{\text{OE}}$  is tied permanently LOW, a LATE WRITE or READ-MODIFY-WRITE is not possible.
17. Write command is defined as  $\overline{\text{WE}}$  going low.
18. LATE WRITE and READ-MODIFY-WRITE cycles must have both  $t_{\text{OD}}$  and  $t_{\text{OEH}}$  met ( $\overline{\text{OE}}$  HIGH during WRITE cycle) in order to ensure that the output buffers will be open during the WRITE cycle. The I/Os will provide the previously written data if  $\overline{\text{CAS}}$  remains LOW and  $\overline{\text{OE}}$  is taken back to LOW after  $t_{\text{OEH}}$  is met.
19. The I/Os are in open during READ cycles once  $t_{\text{OD}}$  or  $t_{\text{OFF}}$  occur.
20. The first  $\chi\overline{\text{CAS}}$  edge to transition LOW.
21. The last  $\chi\overline{\text{CAS}}$  edge to transition HIGH.
22. These parameters are referenced to  $\overline{\text{CAS}}$  leading edge in EARLY WRITE cycles and  $\overline{\text{WE}}$  leading edge in LATE WRITE or READ-MODIFY-WRITE cycles.
23. Last falling  $\chi\overline{\text{CAS}}$  edge to first rising  $\chi\overline{\text{CAS}}$  edge.
24. Last rising  $\chi\overline{\text{CAS}}$  edge to next cycle's last rising  $\chi\overline{\text{CAS}}$  edge.
25. Last rising  $\chi\overline{\text{CAS}}$  edge to first falling  $\chi\overline{\text{CAS}}$  edge.
26. Each  $\chi\overline{\text{CAS}}$  must meet minimum pulse width.
27. Last  $\chi\overline{\text{CAS}}$  to go LOW.
28. I/Os controlled, regardless  $\overline{\text{UCAS}}$  and  $\overline{\text{LCAS}}$ .
29. The 3 ns minimum is a parameter guaranteed by design.
30. Enables on-chip refresh and address counters.

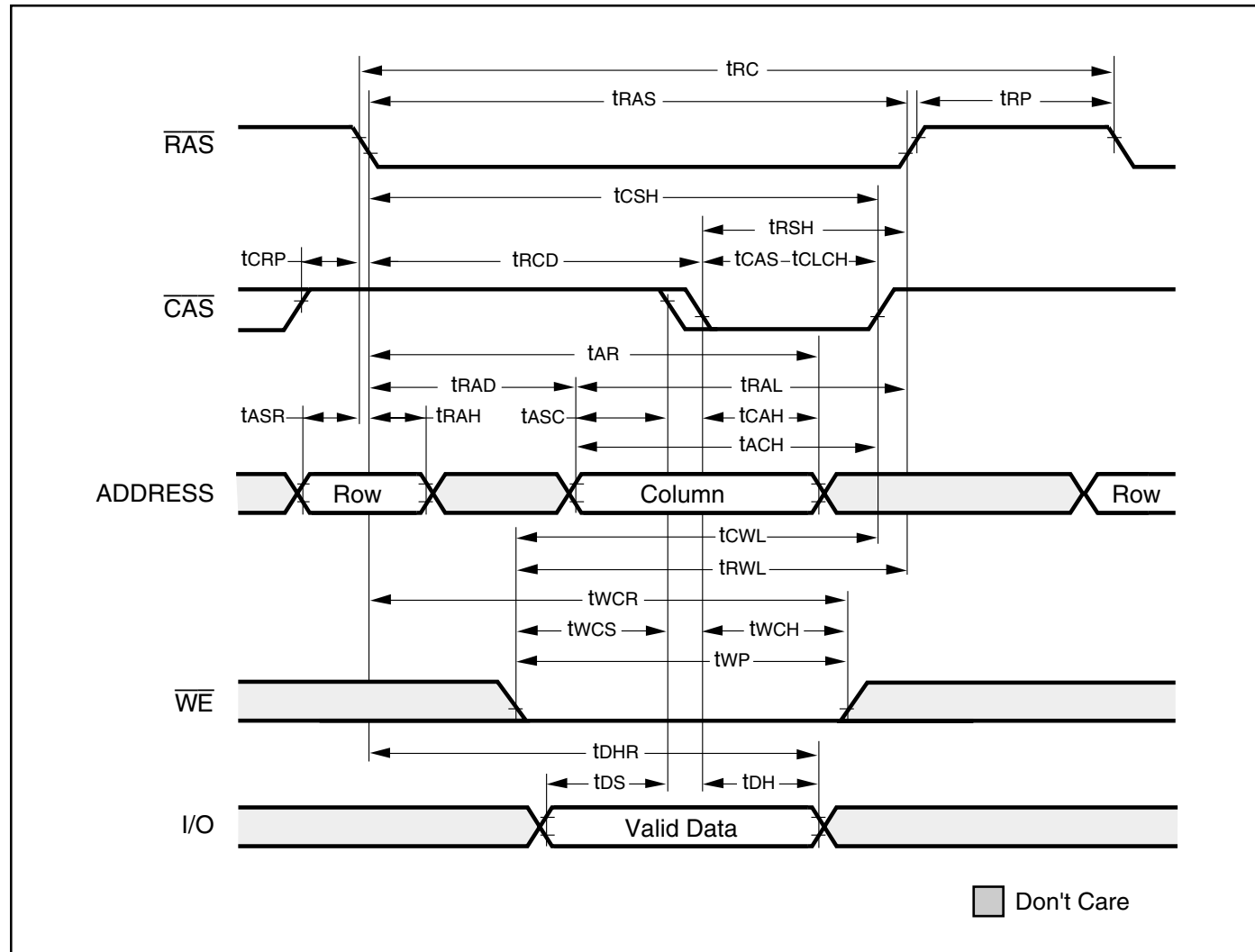
# AC WAVEFORMS READ CYCLE



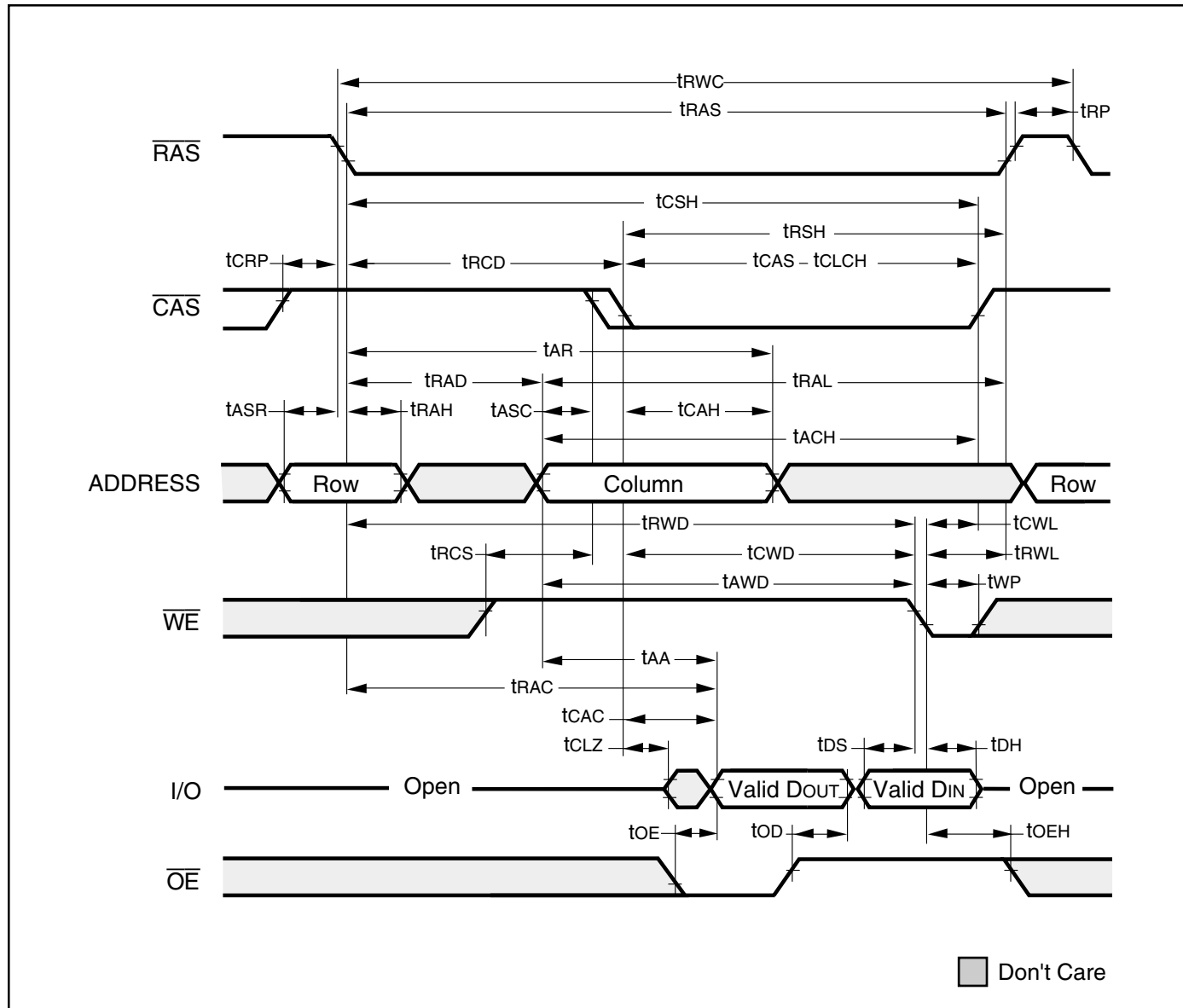
## Note:

1.  $t_{\text{OFF}}$  is referenced from rising edge of  $\overline{\text{RAS}}$  or  $\overline{\text{CAS}}$ , whichever occurs last.

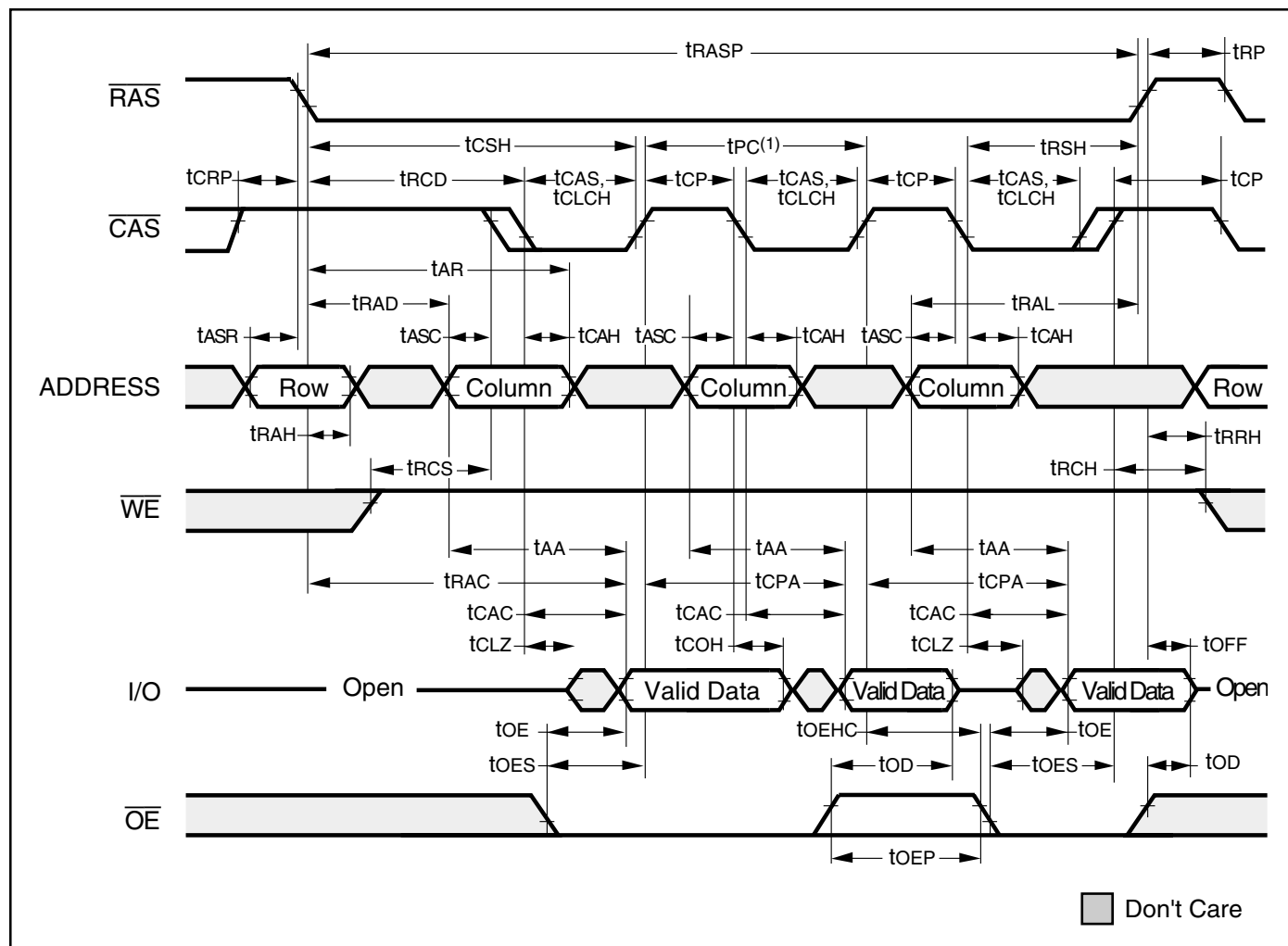
EARLY WRITE CYCLE ( $\overline{OE}$  = DON'T CARE)



# READ WRITE CYCLE (LATE WRITE and READ-MODIFY-WRITE Cycles)



## EDO-PAGE-MODE READ CYCLE



### Note:

1.  $t_{PC}$  can be measured from falling edge of  $\overline{CAS}$  to falling edge of  $\overline{CAS}$ , or from rising edge of  $\overline{CAS}$  to rising edge of  $\overline{CAS}$ . Both measurements must meet the  $t_{PC}$  specifications.

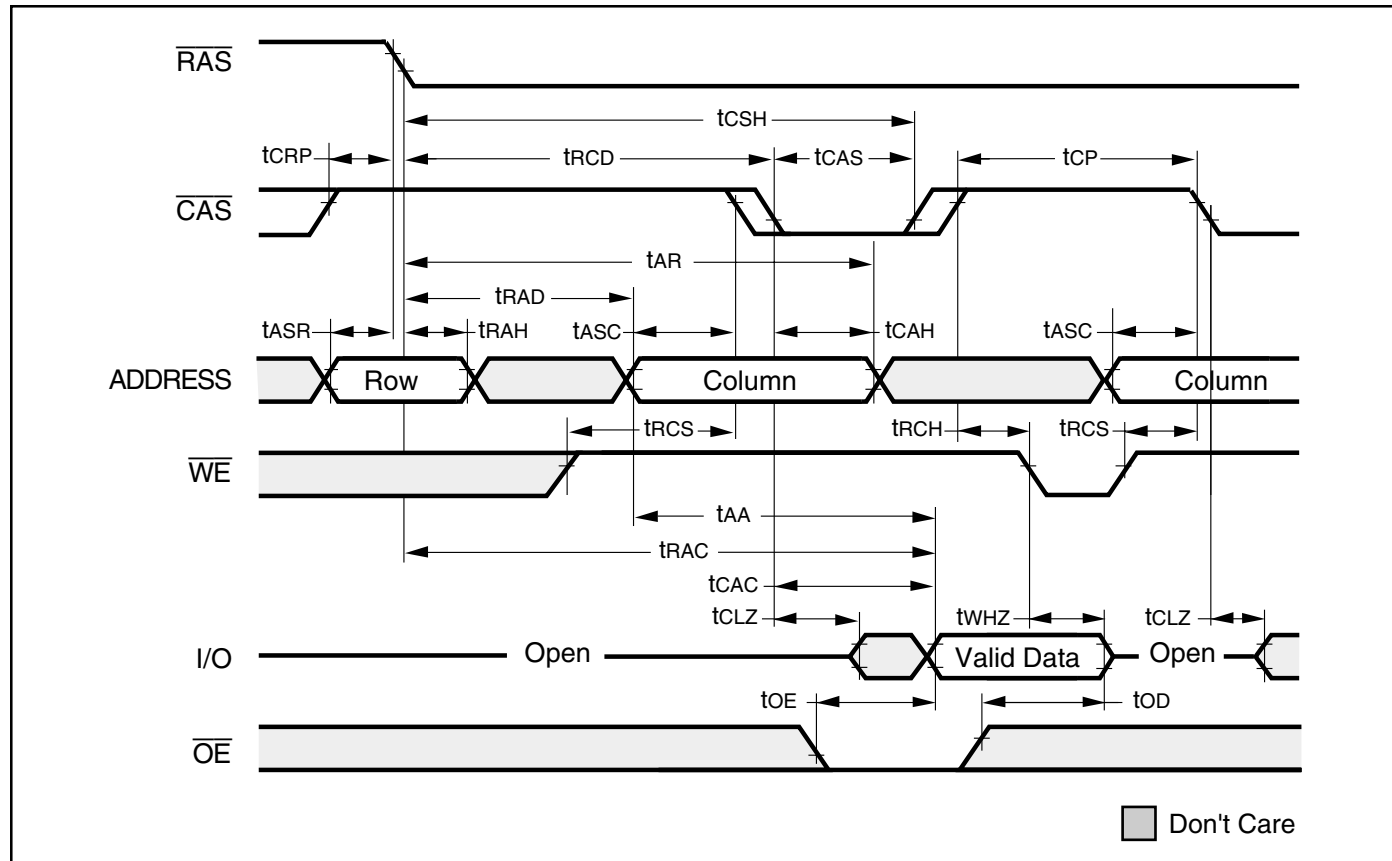
[illegible]

[illegible]

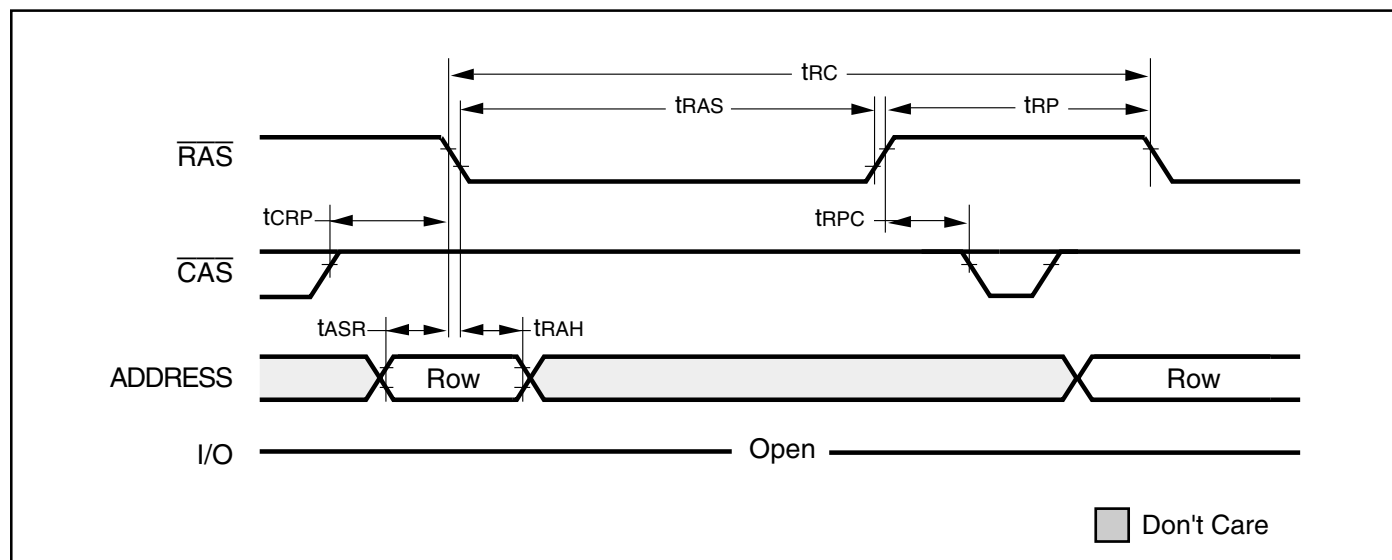
1. tPC can be measured from falling edge of  $\overline{\text{CAS}}$ , or from rising edge of  $\overline{\text{CAS}}$  to rising edge of  $\overline{\text{CAS}}$ . Both measurements must meet the tPC specifications.

The diagram illustrates the timing relationships for a 2D array memory device. The signals shown are  $\overline{\text{RAS}}$ ,  $\overline{\text{CAS}}$ , ADDRESS,  $\overline{\text{WE}}$ , I/O, and  $\overline{\text{OE}}$ . The ADDRESS signal is divided into Row and Column (A, B, ..., N) segments. The I/O signal shows Valid Data (A), Valid Data (B), and DIN. The diagram includes numerous timing parameters such as  $t_{\text{RASP}}$ ,  $t_{\text{CRP}}$ ,  $t_{\text{RCD}}$ ,  $t_{\text{PC}}$ ,  $t_{\text{CAS}}$ ,  $t_{\text{CP}}$ ,  $t_{\text{RSH}}$ ,  $t_{\text{ACH}}$ ,  $t_{\text{RAL}}$ ,  $t_{\text{ASR}}$ ,  $t_{\text{RAD}}$ ,  $t_{\text{ASC}}$ ,  $t_{\text{CAH}}$ ,  $t_{\text{RCS}}$ ,  $t_{\text{AA}}$ ,  $t_{\text{AC}}$ ,  $t_{\text{COH}}$ ,  $t_{\text{DS}}$ ,  $t_{\text{DH}}$ ,  $t_{\text{OE}}$ ,  $t_{\text{WHZ}}$ ,  $t_{\text{WCS}}$ ,  $t_{\text{WCH}}$ ,  $t_{\text{RAH}}$ ,  $t_{\text{RAH}}$ ,  $t_{\text{ASR}}$ ,  $t_{\text{RAD}}$ ,  $t_{\text{ASC}}$ ,  $t_{\text{CAH}}$ ,  $t_{\text{RCS}}$ ,  $t_{\text{AA}}$ ,  $t_{\text{AC}}$ ,  $t_{\text{COH}}$ ,  $t_{\text{DS}}$ ,  $t_{\text{DH}}$ ,  $t_{\text{OE}}$ ,  $t_{\text{WHZ}}$ ,  $t_{\text{WCS}}$ ,  $t_{\text{WCH}}$ .

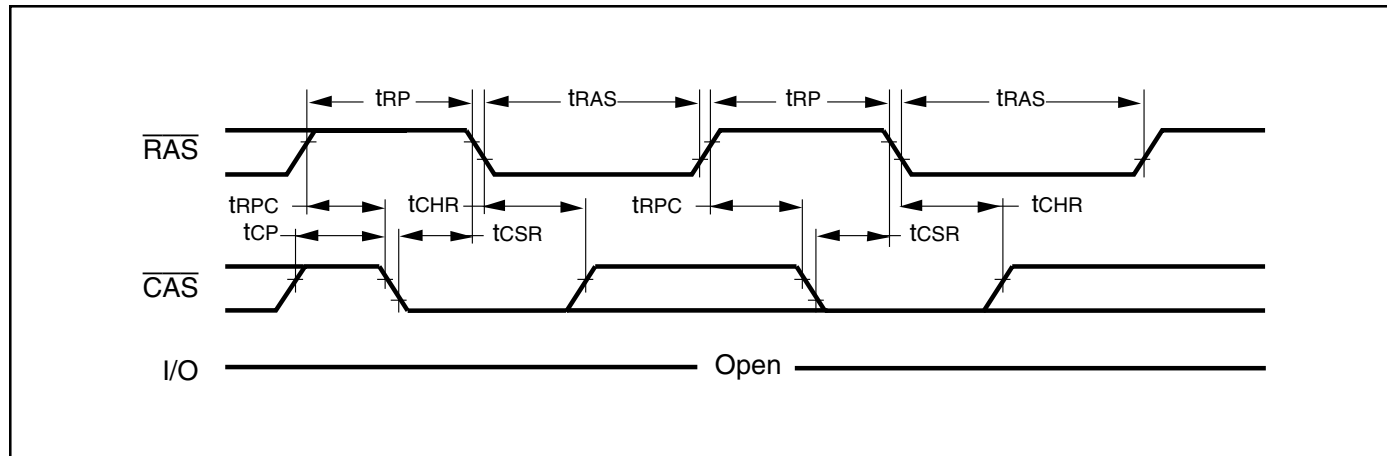
## READ CYCLE (With $\overline{WE}$ -Controlled Disable)



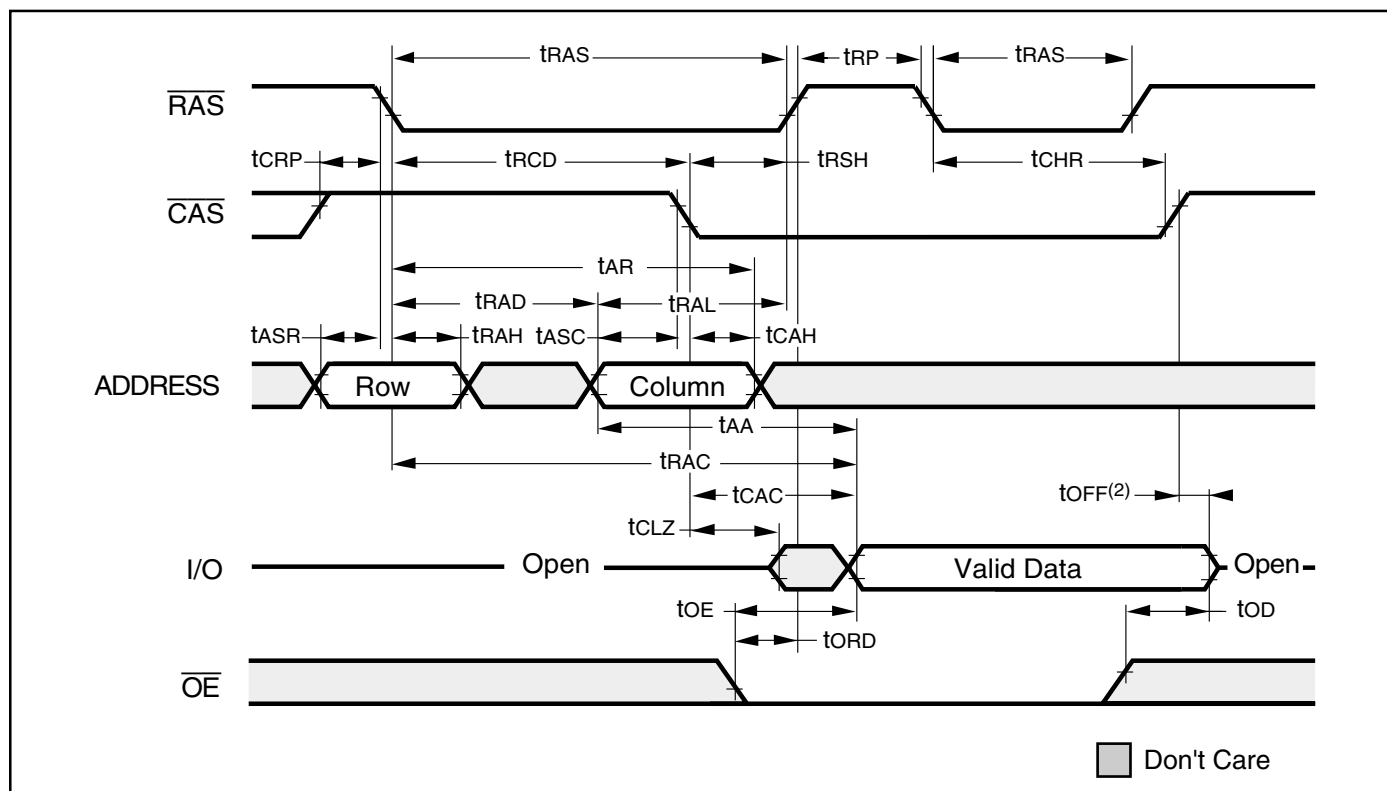
## $\overline{RAS}$ -ONLY REFRESH CYCLE ( $\overline{OE}$ , $\overline{WE}$ = DON'T CARE)



**$\overline{\text{CBR}}$  REFRESH CYCLE (Addresses;  $\overline{\text{WE}}$ ,  $\overline{\text{OE}}$  = DON'T CARE)**



**HIDDEN REFRESH CYCLE ( $\overline{\text{WE}}$  = HIGH;  $\overline{\text{OE}}$  = LOW)<sup>(1)</sup>**



**Notes:**

1. A Hidden Refresh may also be performed after a Write Cycle. In this case,  $\overline{\text{WE}}$  = LOW and  $\overline{\text{OE}}$  = HIGH.
2.  $t_{OFF}$  is referenced from rising edge of RAS or CAS, whichever occurs last.

**ORDERING INFORMATION : 5V**  
**Commercial Range: 0°C to 70°C**

| Speed (ns) | Order Part No. | Package     |
|------------|----------------|-------------|
| 35         | IS41C85120-35K | 400-mil SOJ |
| 60         | IS41C85120-60K | 400-mil SOJ |

**ORDERING INFORMATION : 3.3V**  
**Commercial Range: 0°C to 70°C**

| Speed (ns) | Order Part No.  | Package     |
|------------|-----------------|-------------|
| 35         | IS41LV85120-35K | 400-mil SOJ |
| 60         | IS41LV85120-60K | 400-mil SOJ |

**ORDERING INFORMATION : 5V**  
**Industrail Range: -40°C to 85°C**

| Speed (ns) | Order Part No.  | Package     |
|------------|-----------------|-------------|
| 60         | IS41C85120-60KI | 400-mil SOJ |

**ORDERING INFORMATION : 3.3V**  
**Industrail Range: -40°C to 85°C**

| Speed (ns) | Order Part No.   | Package     |
|------------|------------------|-------------|
| 60         | IS41LV85120-60KI | 400-mil SOJ |

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